

BFQ19S

NPN Silicon RF Transistor*

- For low noise, low distortion broadband amplifiers in antenna and telecommunications systems up to 1.5 GHz at collector currents from 10 mA to 70 mA
- Pb-free (RoHS compliant) package¹⁾
- Qualified according AEC Q101
- * Short term description



ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration			Package
BFQ19S	FG	1 = B	2 = C	3 = E	SOT89

Maximum Ratings

Parameter	Symbol	Value	Unit	
Collector-emitter voltage	V _{CEO}	15	V	
Collector-emitter voltage	V _{CES}	20		
Collector-base voltage	V _{CBO}	20		
Emitter-base voltage	V _{EBO}	3		
Collector current	I _C	210	mA	
Base current	I _B	21		
Total power dissipation ²⁾	P _{tot}	1	W	
<i>T</i> _S ≤ 85°C				
Junction temperature	T _i	150	°C	
Operation junction temperature range	T _{jo}		-	
Ambient temperature	T _A	-65 150	°C	
Storage temperature	T _{stg}	-65 150		

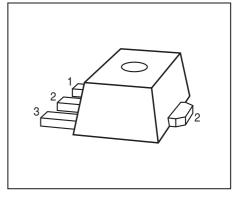
Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ³⁾	R _{thJS}	≤ 65	K/W

¹Pb-containing package may be available upon special request

 $^{2}T_{S}$ is measured on the collector lead at the soldering point to the pcb

³For calculation of R_{thJA} please refer to Application Note Thermal Resistance





Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage	V _{(BR)CEO}	15	-	-	V
<i>I</i> _C = 1 mA, <i>I</i> _B = 0					
Collector-emitter cutoff current	I _{CES}	-	-	10	μA
$V_{\rm CE}$ = 20 V, $V_{\rm BE}$ = 0					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB}$ = 10 V, $I_{\rm E}$ = 0					
Emitter-base cutoff current	I _{EBO}	-	-	100	μA
$V_{\rm EB}$ = 2 V, $I_{\rm C}$ = 0					
DC current gain-	h _{FE}	70	100	140	-
$I_{\rm C}$ = 70 mA, $V_{\rm CE}$ = 8 V, pulse measured					

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified



Parameter	Symbol		Values		
		min.	typ.	max.	
AC Characteristics (verified by random samplin	ig)		1	1	1
Transition frequency	f _T	4	5.5	-	GHz
<i>I</i> _C = 70 mA, <i>V</i> _{CE} = 8 V, <i>f</i> = 500 MHz					
Collector-base capacitance	C _{cb}	-	1.05	1.35	pF
$V_{\rm CB}$ = 10 V, f = 1 MHz, $V_{\rm BE}$ = 0 ,					
emitter grounded					
Collector emitter capacitance	C _{ce}	-	0.4	-	
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
base grounded					
Emitter-base capacitance	C _{eb}	-	3.9	-	
$V_{\rm EB}$ = 0.5 V, f = 1 MHz, $V_{\rm CB}$ = 0 ,					
collector grounded					
Noise figure	F				dB
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 6 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
<i>f</i> = 900 MHz		-	1.8	-	
<i>f</i> = 1.8 GHz		-	3	-	
Power gain, maximum available ¹⁾	G _{ma}				
$I_{\rm C}$ = 70 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,					
<i>f</i> = 900 MHz		-	11.5	-	
<i>f</i> = 1.8 GHz		-	7	-	
Transducer gain	S _{21e} ²				dB
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
<i>f</i> = 900 MHz		-	9.5	-	
<i>f</i> = 1.8 GHz		-	4	-	
Third order intercept point at output	IP ₃	-	32	-	dBm
V_{CE} = 8 V, I_{C} = 70 mA, Z_{S} = Z_{Sopt} , Z_{L} = Z_{Lopt} ,					
<i>f</i> = 1.8 GHz					

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified

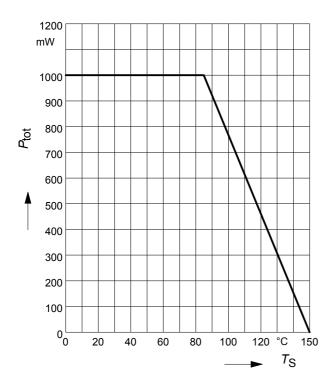
 ${}^{1}\mathrm{G}_{\mathrm{ma}} = |\mathrm{S}_{21}/\mathrm{S}_{12}| \; (\mathrm{k}\text{-}(\mathrm{k}^{2}\text{-}1)^{1/2})$



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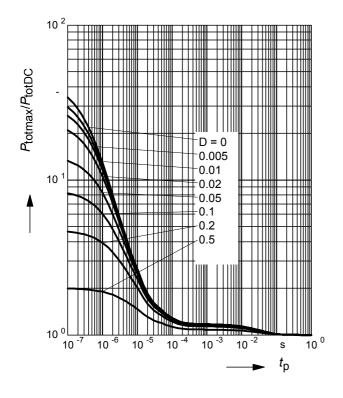
Total power dissipation $P_{tot} = f(T_S)$

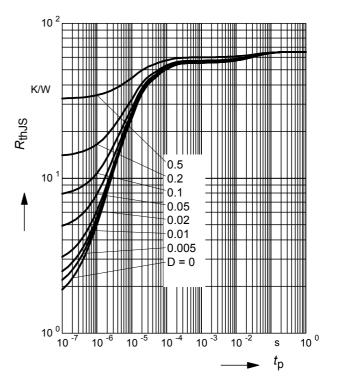
Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$



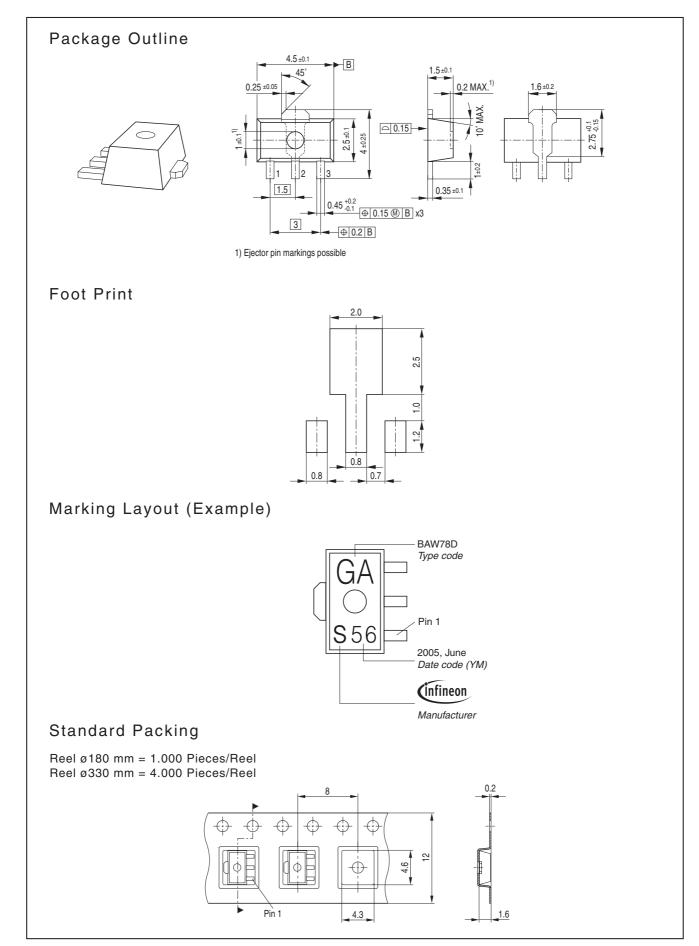
Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$











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